

RJK0215DPA

Silicon N Channel Power MOS FET with Schottky Barrier Diode High Speed Power Switching

R07DS0207EJ0110

Rev.1.10

Sep 05, 2011

Applications

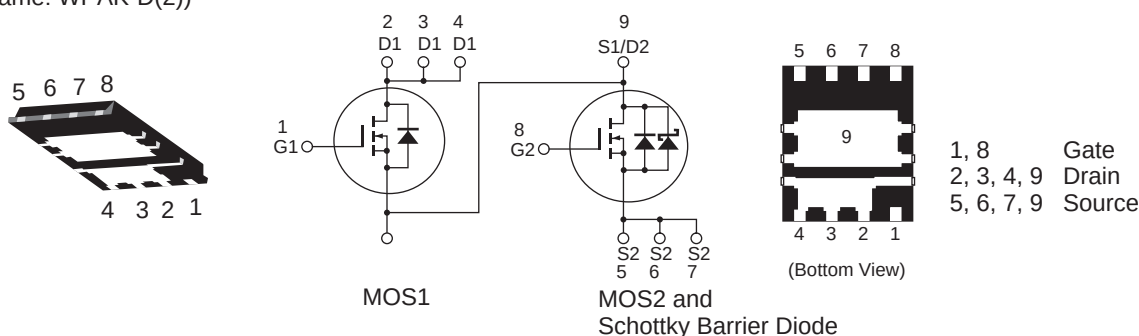
DC-DC conversion for PC and Server.

Features

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting
- Pb-free
- Halogen-free

Outline

RENESAS Package code: PWSN0008DD-A
(Package name: WPAK-D(2))



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings		Unit
		MOS1	MOS2	
Drain to source voltage	V_{DSS}	25	25	V
Gate to source voltage	V_{GSS}	±20	±20	V
Drain current	I_D	15	40	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	60	160	A
Reverse drain current	I_{DR}	15	40	A
Avalanche current	I_{AP} ^{Note 2}	5	14	A
Avalanche energy	E_{AR} ^{Note 2}	3.1	24.5	mJ
Channel dissipation	P_{ch} ^{Note3}	10	25	W
Channel temperature	T_{ch}	150	150	°C
Storage temperature	T_{stg}	-55 to +150	-55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$
 2. Value at $T_{ch} = 25^\circ C$, $R_g \geq 50 \Omega$
 3. $T_c = 25^\circ C$

Electrical Characteristics

• MOS1

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	25	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = \pm 20 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	μA	$V_{DS} = 25 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	—	2.5	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	7.6	9.2	$\text{m}\Omega$	$I_D = 7.5 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note4}
	$R_{DS(on)}$	—	10.5	13.7	$\text{m}\Omega$	$I_D = 7.5 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note4}
Forward transfer admittance	$ y_{fs} $	—	30	—	S	$I_D = 7.5 \text{ A}$, $V_{DS} = 5 \text{ V}$ ^{Note4}
Input capacitance	C_{iss}	—	810	1130	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	130	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	74	—	pF	$f = 1 \text{ MHz}$
Gate Resistance	R_g	—	1.2	2.4	Ω	
Total gate charge	Q_g	—	6.2	—	nC	$V_{DD} = 10 \text{ V}$
Gate to source charge	Q_{gs}	—	2.8	—	nC	$V_{GS} = 4.5 \text{ V}$
Gate to drain charge	Q_{gd}	—	1.9	—	nC	$I_D = 15 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	7.3	—	ns	$V_{GS} = 10 \text{ V}$, $I_D = 7.5 \text{ A}$
Rise time	t_r	—	5.3	—	ns	$V_{DD} \approx 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	33.9	—	ns	$R_L = 1.33 \Omega$
Fall time	t_f	—	5.4	—	ns	$R_g = 4.7 \Omega$
Body-drain diode forward voltage	V_{DF}	—	0.84	1.10	V	$I_F = 15 \text{ A}$, $V_{GS} = 0$ ^{Note4}
Body-drain diode reverse recovery time	t_{rr}	—	20	—	ns	$I_F = 15 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Notes: 4. Pulse test

• MOS2

(Ta = 25°C)

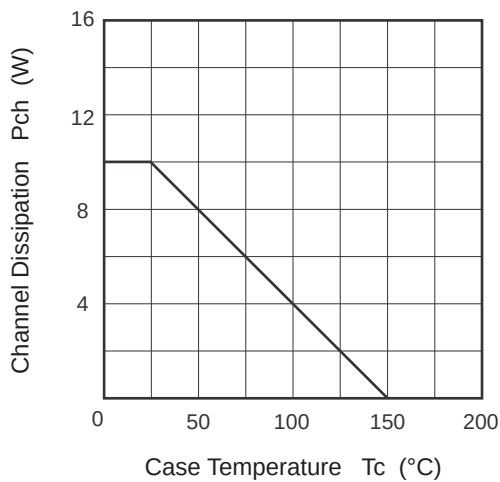
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	25	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = \pm 20 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	mA	$V_{DS} = 25 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	—	2.5	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	2.5	3.0	$\text{m}\Omega$	$I_D = 20 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note4}
	$R_{DS(on)}$	—	3.7	4.8	$\text{m}\Omega$	$I_D = 20 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note4}
Forward transfer admittance	$ y_{fs} $	—	77	—	S	$I_D = 20 \text{ A}$, $V_{DS} = 5 \text{ V}$ ^{Note4}
Input capacitance	C_{iss}	—	2500	3500	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	460	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	260	—	pF	$f = 1 \text{ MHz}$
Gate Resistance	R_g	—	1.9	3.8	Ω	
Total gate charge	Q_g	—	17.5	—	nC	$V_{DD} = 10 \text{ V}$
Gate to source charge	Q_{gs}	—	7.6	—	nC	$V_{GS} = 4.5 \text{ V}$
Gate to drain charge	Q_{gd}	—	4.6	—	nC	$I_D = 40 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	11.1	—	ns	$V_{GS} = 10 \text{ V}$, $I_D = 20 \text{ A}$
Rise time	t_r	—	7.3	—	ns	$V_{DD} \approx 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	49.1	—	ns	$R_L = 0.5 \Omega$
Fall time	t_f	—	7.6	—	ns	$R_g = 4.7 \Omega$
Schottky Barrier diode forward voltage	V_F	—	0.39	—	V	$I_F = 2 \text{ A}$, $V_{GS} = 0$ ^{Note4}
Body-drain diode reverse recovery time	t_{rr}	—	24	—	ns	$I_F = 40 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Notes: 4. Pulse

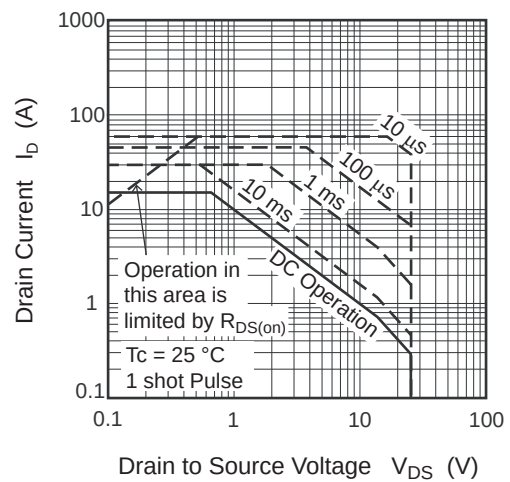
Main Characteristics

• MOS1

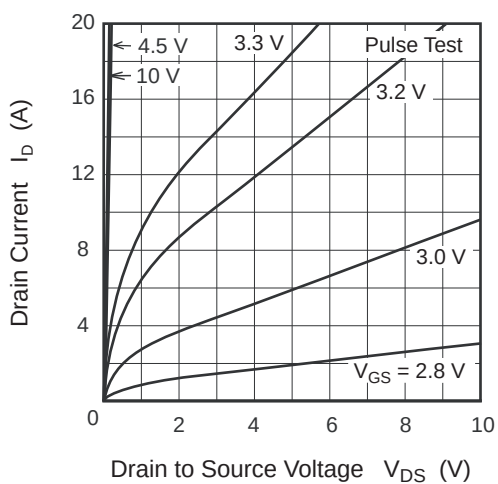
Power vs. Temperature Derating



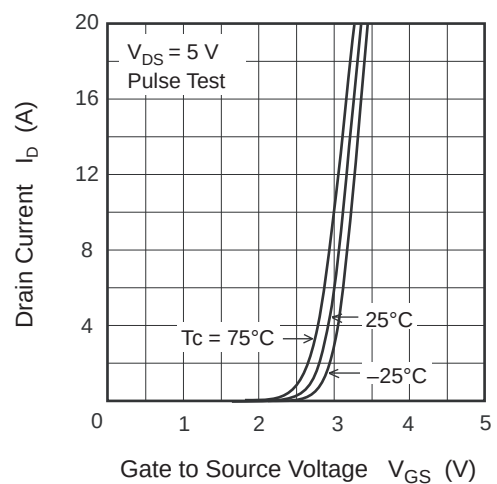
Maximum Safe Operation Area



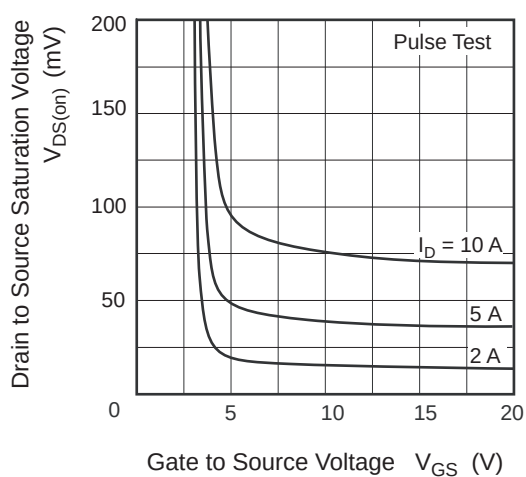
Typical Output Characteristics



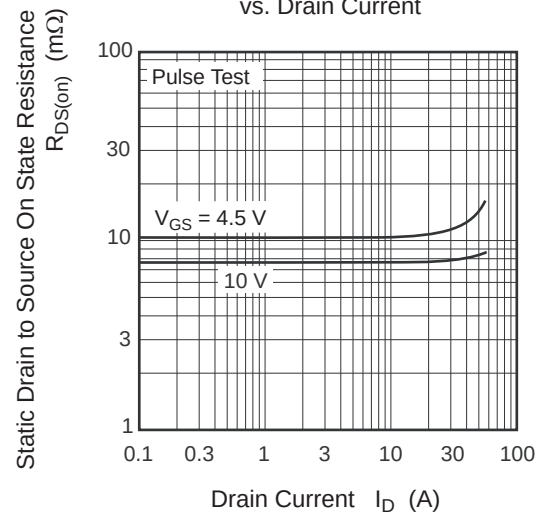
Typical Transfer Characteristics

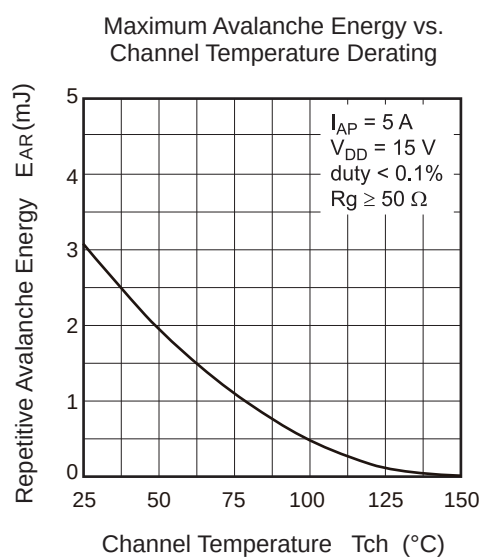
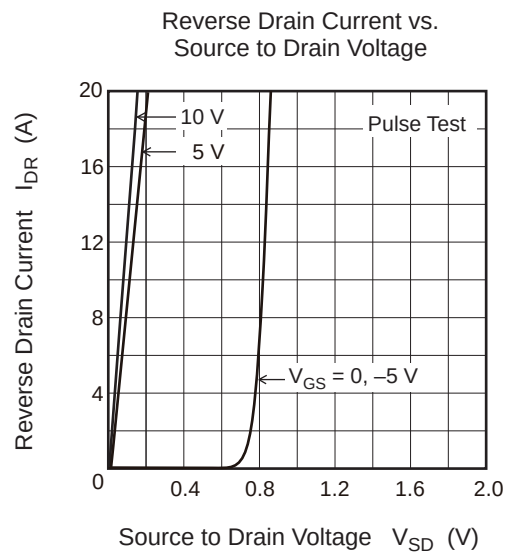
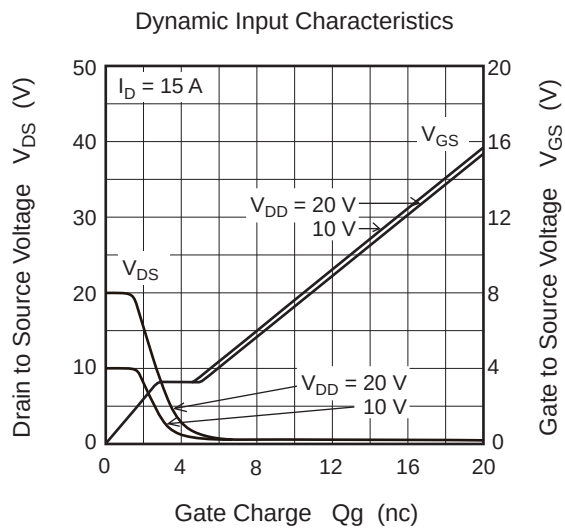
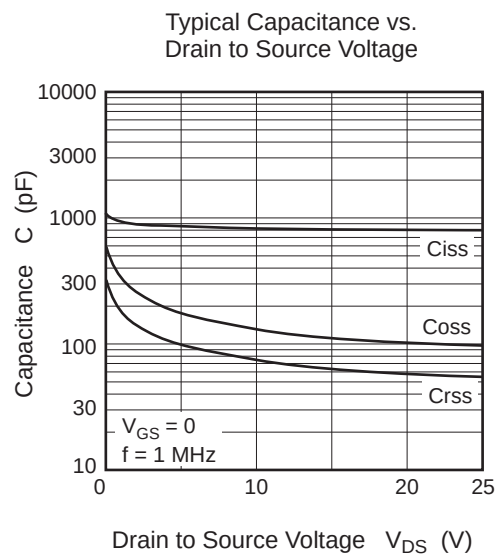
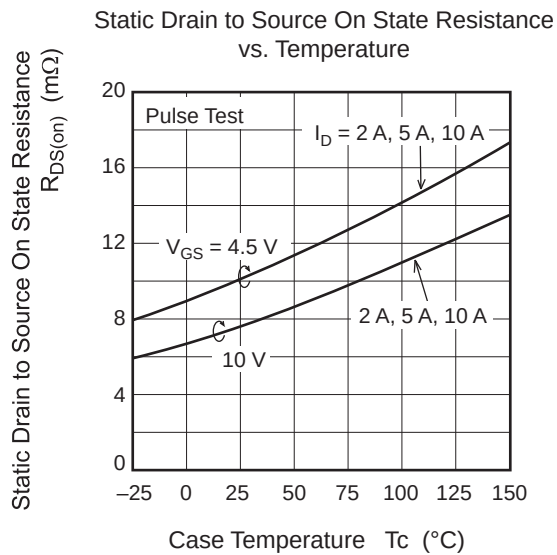


Drain to Source Saturation Voltage vs. Gate to Source Voltage

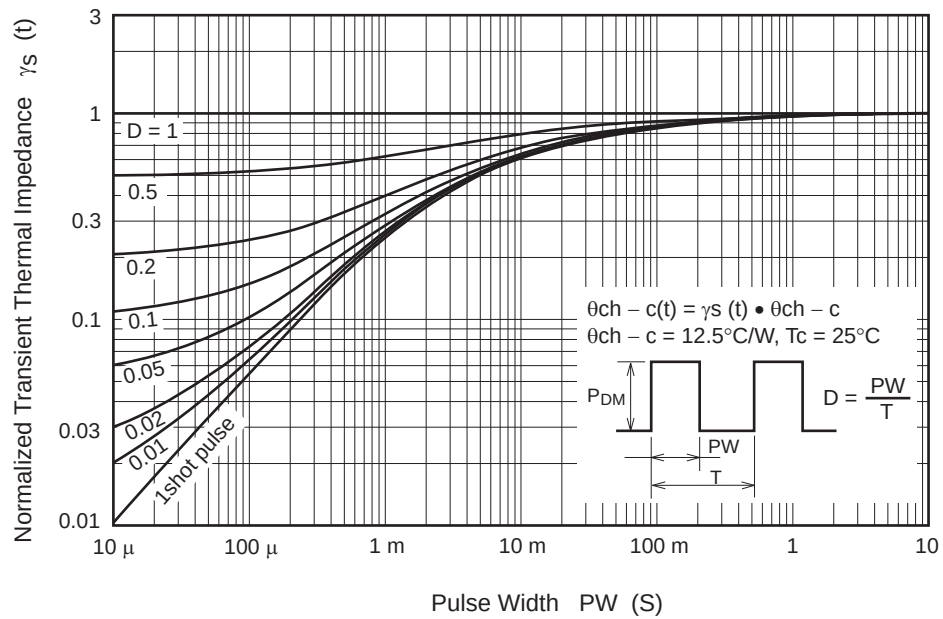


Static Drain to Source On State Resistance vs. Drain Current

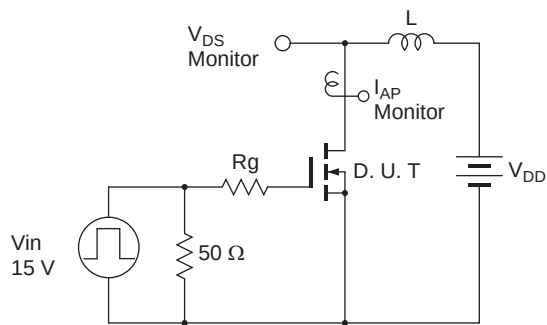




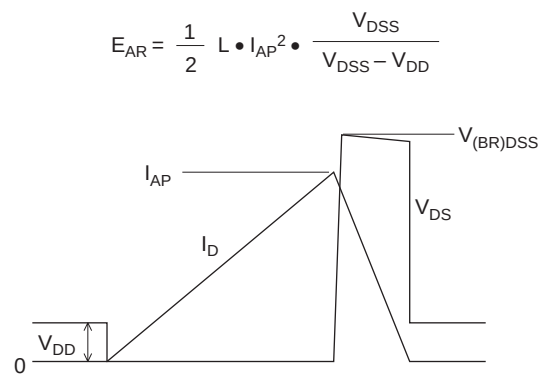
Normalized Transient Thermal Impedance vs. Pulse Width



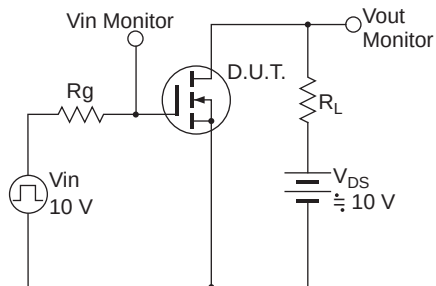
Avalanche Test Circuit



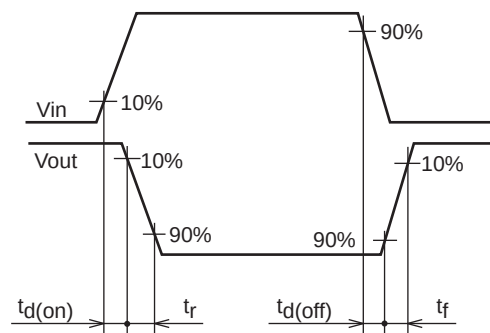
Avalanche Waveform



Switching Time Test Circuit

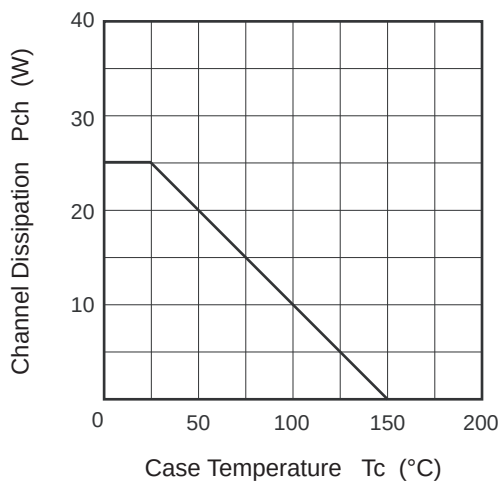


Switching Time Waveform

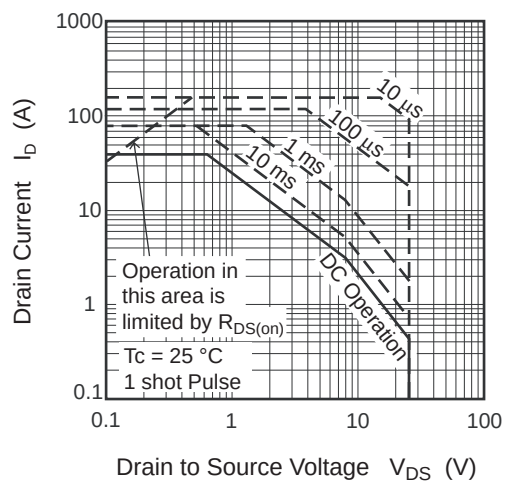


• MOS2 and Schottky Barrier Diode

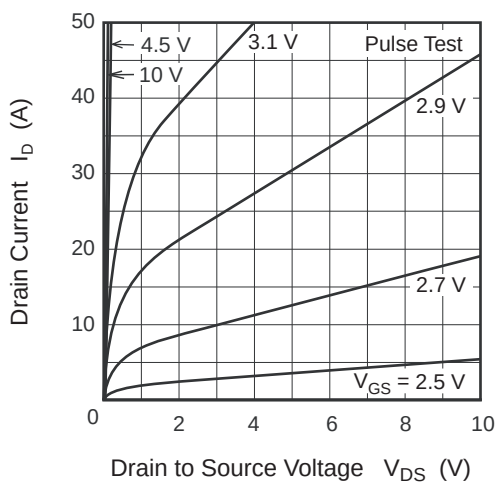
Power vs. Temperature Derating



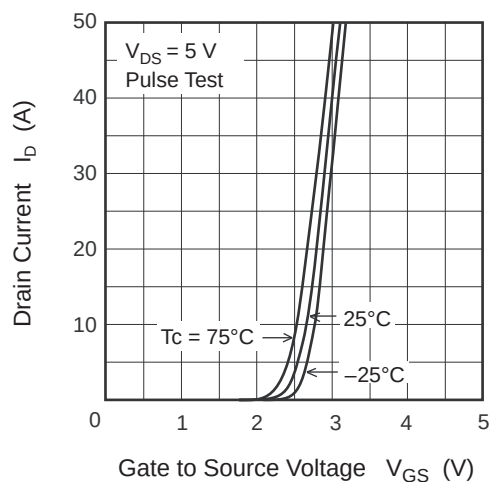
Maximum Safe Operation Area



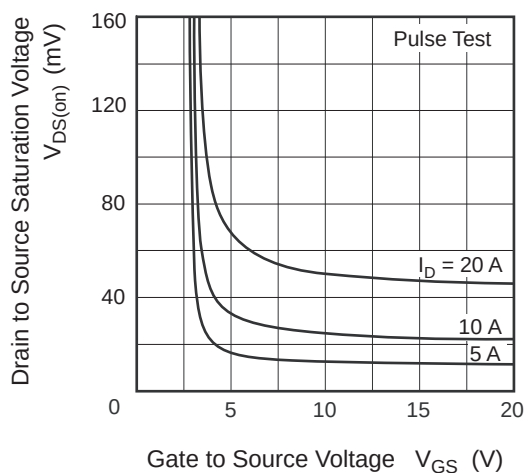
Typical Output Characteristics



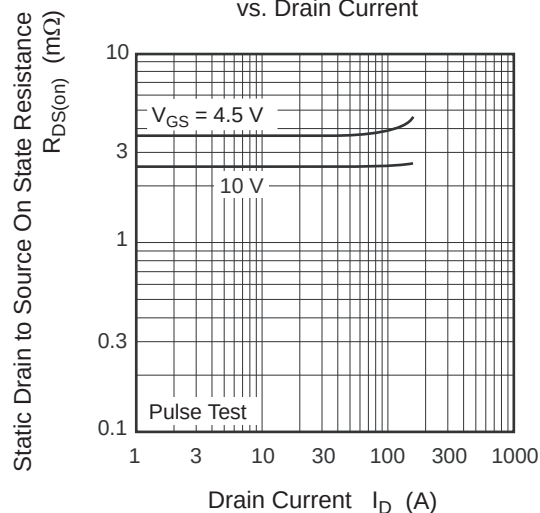
Typical Transfer Characteristics

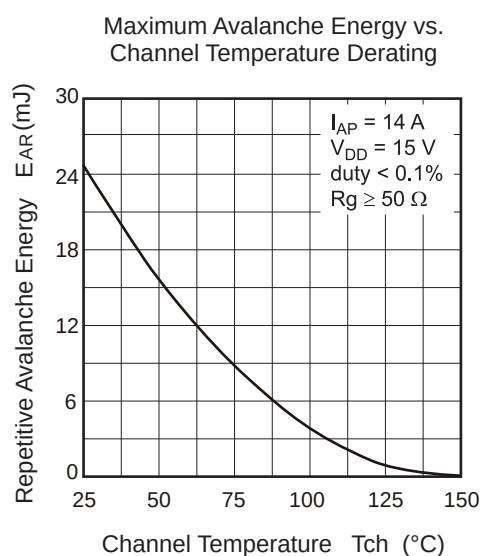
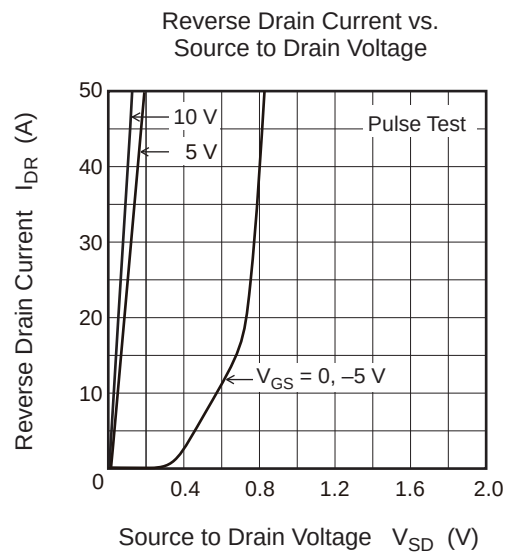
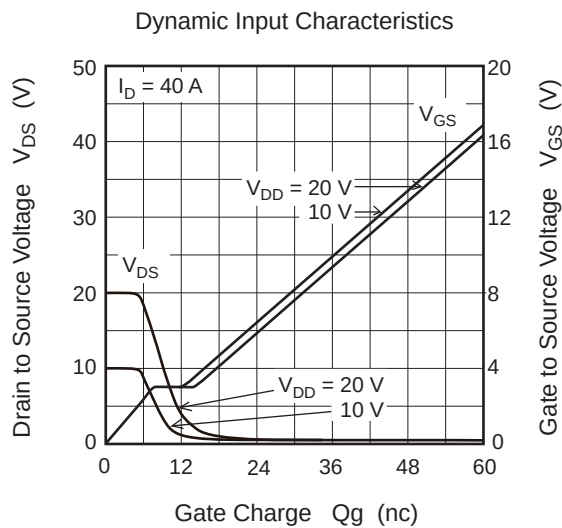
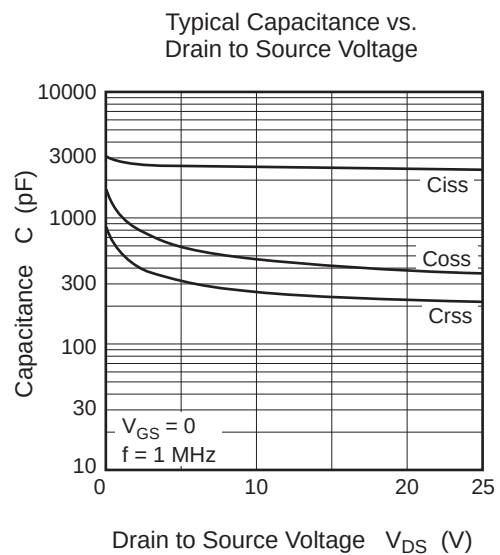
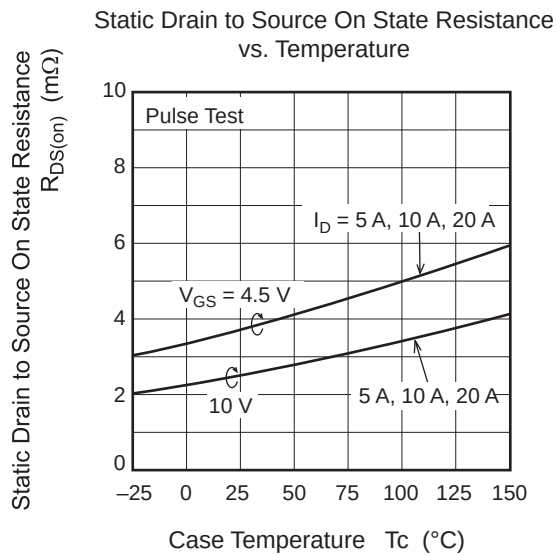


Drain to Source Saturation Voltage vs. Gate to Source Voltage

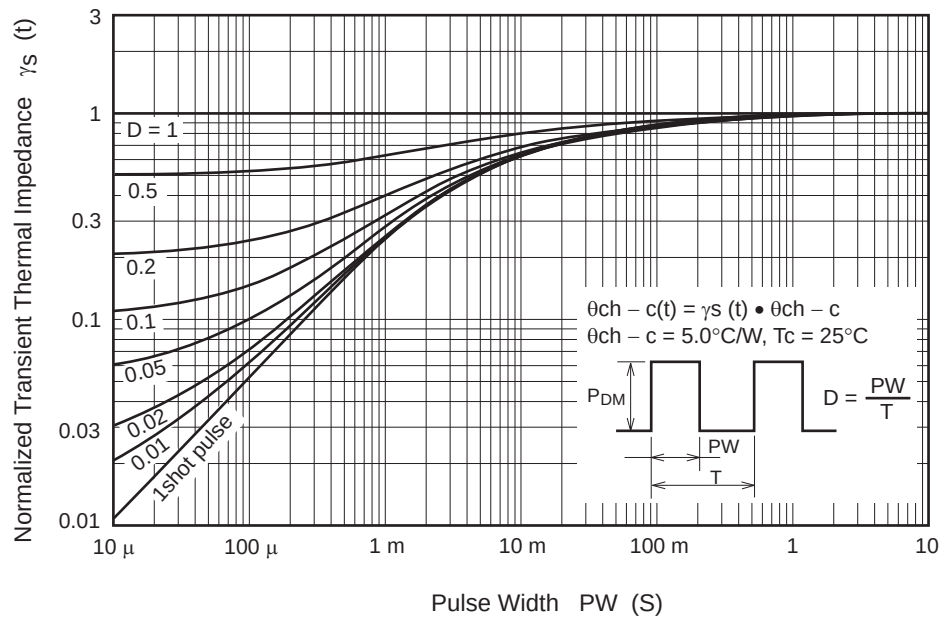


Static Drain to Source On State Resistance vs. Drain Current

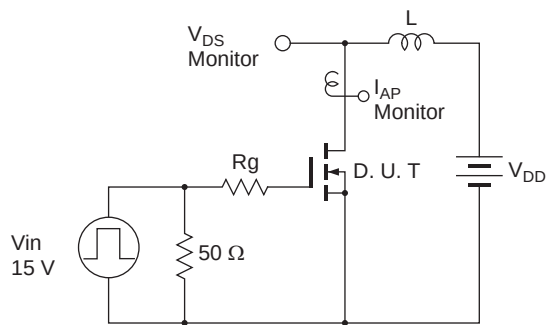




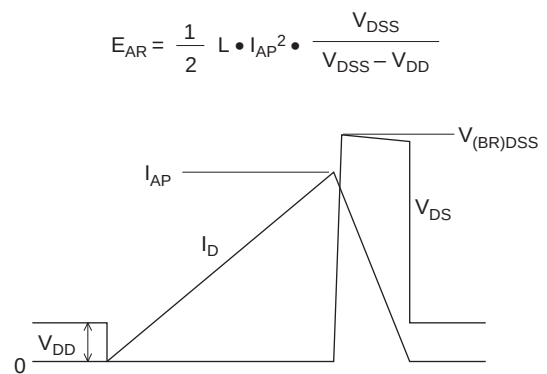
Normalized Transient Thermal Impedance vs. Pulse Width



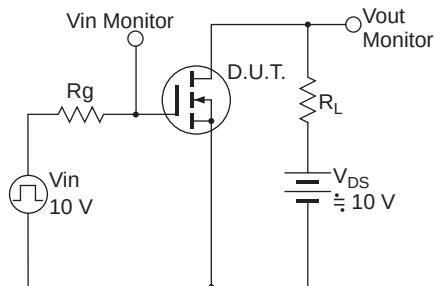
Avalanche Test Circuit



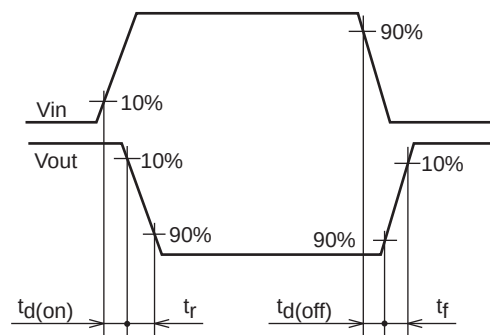
Avalanche Waveform



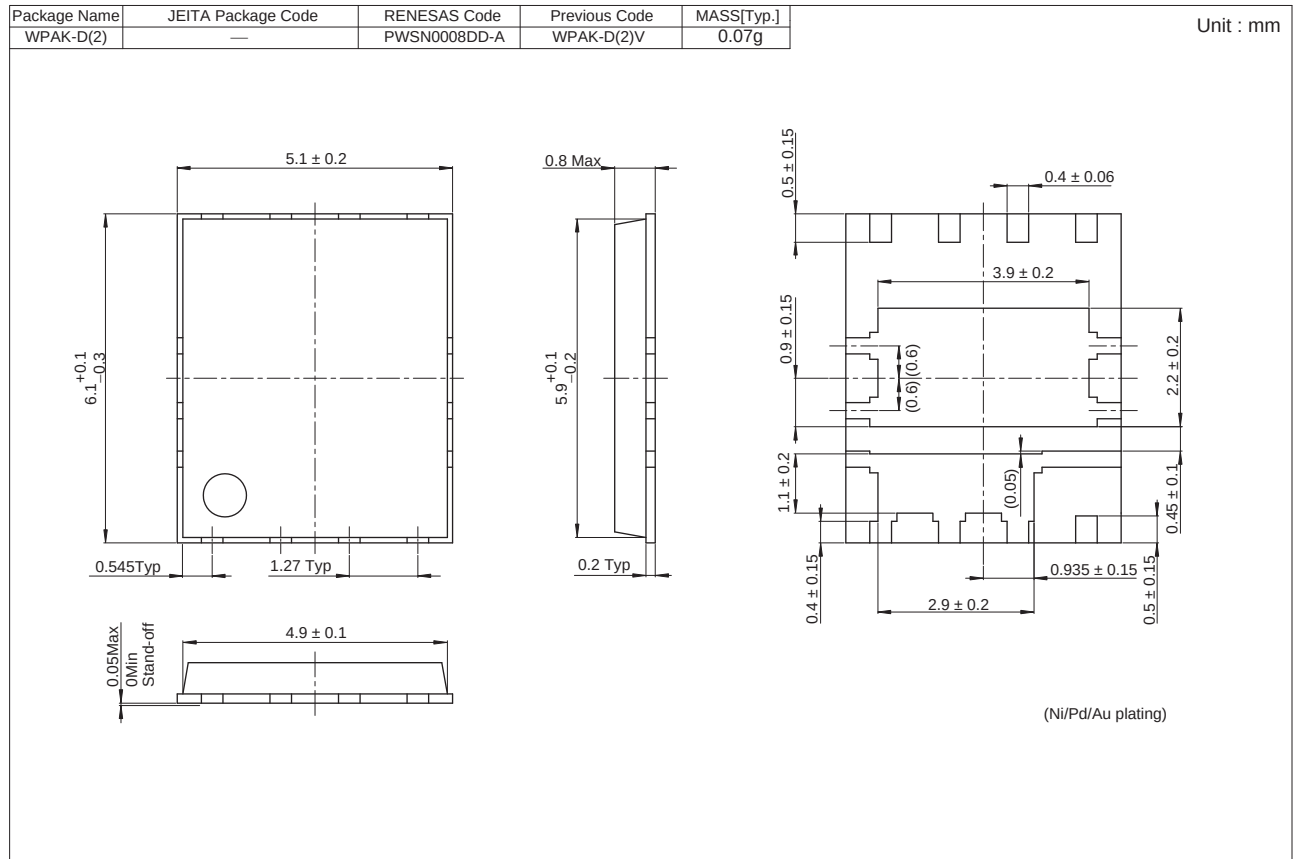
Switching Time Test Circuit



Switching Time Waveform



Package Dimensions



Ordering Information

Orderable Part Number	Quantity	Shipping Container
RJK0215DPA-00-J53	3000 pcs	Taping

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